

承認書

SPECIFICATION FOR APPROVAL

CUSTOMER: 2144

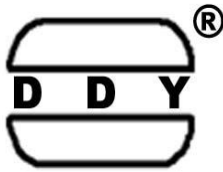
DESCRIPTION: WIRE WOUND CHIP INDUCTOR

DDY PART NO: WI0805LD-TIA系列

CUSTOMER MODEL NO: _____

DRAWING		
MADE	CHECKED	APPROVED
谭晶晶	黄志伟	肖中华
DATE:	2023年9月19日	

CUSTOMER APPROVE



惠州市德立电子有限公司
HUI ZHOU DE LI ELECTRONICS CO., LTD

廣東省博羅縣洲際工業園梅園三路
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惠州市德立电子有限公司

HUI ZHOU DE LI ELECTRONICS CO., LTD

CUSTOMER:		REV NO:	A
DESCRIPTION:	WIRE WOUND CHIP INDUCTOR	PAGE NO:	PAGE 1 OF 6
PART NO:	WI0805LD-TIA系列	SN.	
CUSTOMER NO:		DATE:	2023年9月19日

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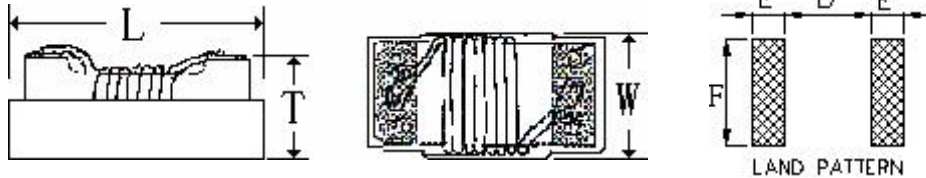
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CUSTOMER:		REV NO:	A
DESCRIPTION:	WIRE WOUND CHIP INDUCTOR	PAGE NO:	PAGE 3 OF 6
PART NO:	WI0805LD-TIA系列	SN.	
CUSTOMER NO:		DATE:	2023年9月19日

1.SHAPE & DIMENSION

UNIT:mm



CODE		L(MAX)	W(MAX)	T(MAX)	E(Typ.)	F(Typ.)	D(Typ.)
DIMENSION	WI0805LD-TIA	2.40	1.73	1.52	1.02	1.78	0.76

3. PART NUMBERING SYSTEM

WI **0805** **LD** **2R2** **K** **S** **T** **-** **HF**
1 **2** **3** **4** **5** **6** **7** **8**

- 1 PRODUCT SYMBOL (产品代号)
- 2 DIMENSIONS (规格尺寸)
- 3 MATERIAL (芯片类型)
- 4 INDUCTANCE (电感量)
- 5 TOLERANCE (公差) : J±5%; K±10%; M±20%
- 6 TERMINAL (端电极材料) : S-锡端头
- 7 PACKAGING (包装方式) : T-编带盘装; B-散装
- 8 E.P. (环保) : LF—Lead Free HF—Halogen Free FP—Red Phosphor Free

4.GENERAL SPECIFICATION

- a. Rating DC current: Temperature rise(ΔT) is 40°C approximately at Irms.
- b. Operating temp.: -40°C~ +85°C
- c. Storage temp.: -10°C ~ +40°C R.H.: 65% Max
- d. Moisture sensitivity level (MSL) 2 (1 year floor life at <30°C/65% relative humidity)

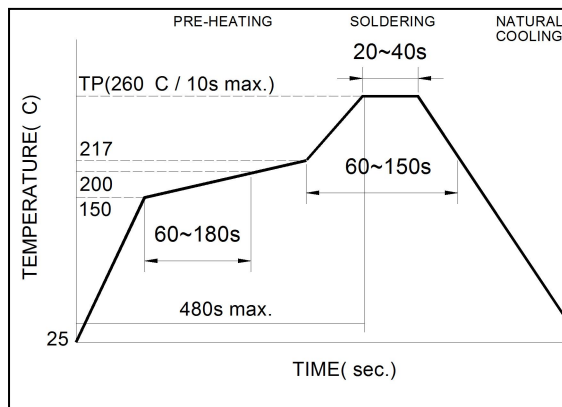
APPROVED BY	CHECKED BY	DRAFT
肖中华	黄志伟	谭晶晶



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6. SOLDERING CONDITIONS

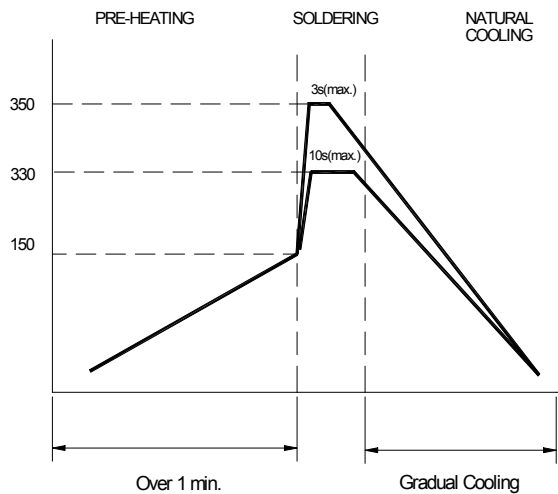
**Figure 1.
Re-flow
Soldering
(Lead Free)**



Note:

- Preheat circuit and products to 150°C
- 260°C tip temperature (max)
- Reflow times: no more than 2 times
- Solder paste thickness: the best 0.08mm is ,but max is 0.1mm

**Figure 2.
Hand
Soldering**



Note:

- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 sec.

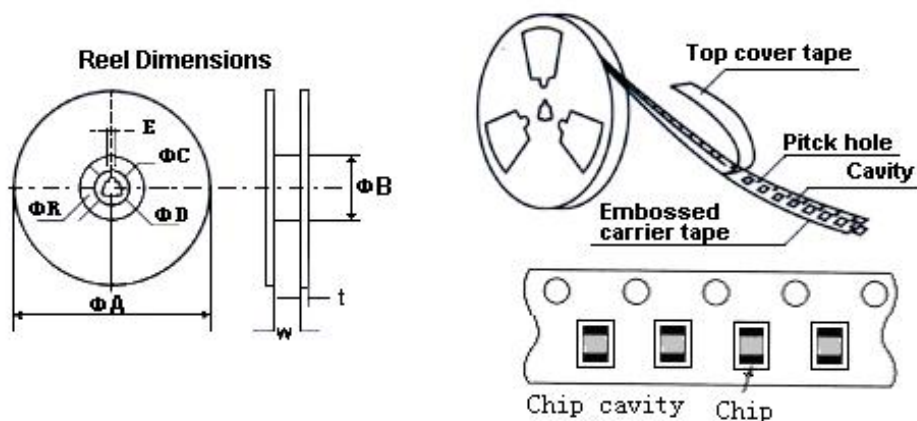
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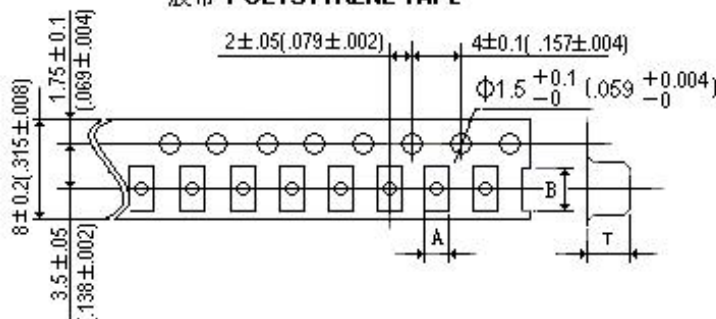
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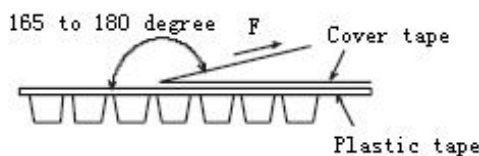
7. PACKAGING(unit: mm)



胶带 POLYSTYRENE TAPE



Peeling off force
Pull strength
0402~1210:20g~80g
Speed of peeling off:
300mm/min±10%



胶带		A	B	T
	0805	1.85	2.4	1.45

Type	ΦA	ΦB	ΦC	ΦD	E	W	t
0805	178	60	13	21	2	8.4	2

包装数量(PACKAGING QUANTITY): 2000Pcs/盘

注意:

此物料不涉及汽车或相关产品方面的应用, 否则, 由此引起的一切品质和责任问题, 我司将概不承担。

APPROVED BY	CHECKED BY	DRAFT
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